

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Applicant(s): Tai-Peng Lee; Chuck Jang
Assignee: Mosel Vitelic, Inc.
Title: Reduced Thickness Variation In A Material Layer Deposited In Narrow
and Wide Integrated Circuit Trenches
Serial No.: 10/033,114 Filing Date: October 22, 2001
Examiner: Garcia, Joanne A. Group Art Unit: 2823
Docket No.: M-11912 US

Fee
only

San Jose, California
July 1, 2005

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AMENDMENT

Dear Sir:

In response to the Office Action having a mailing date of November 18, 2004, please
amend the application as set forth below.

Claims Listing begins on page 2 of this paper.

Remarks begin on page 12 of this paper.

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